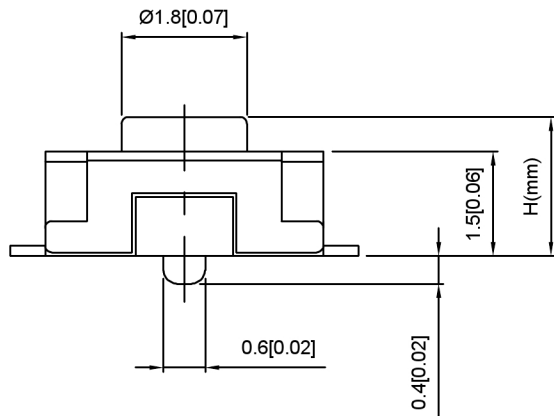
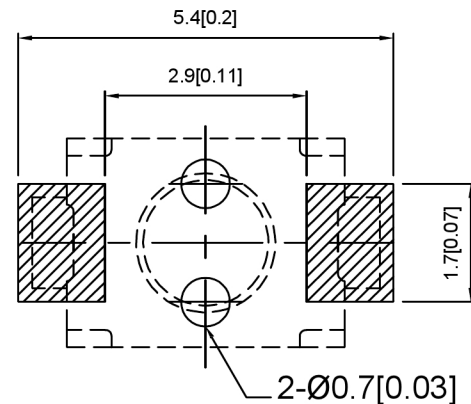
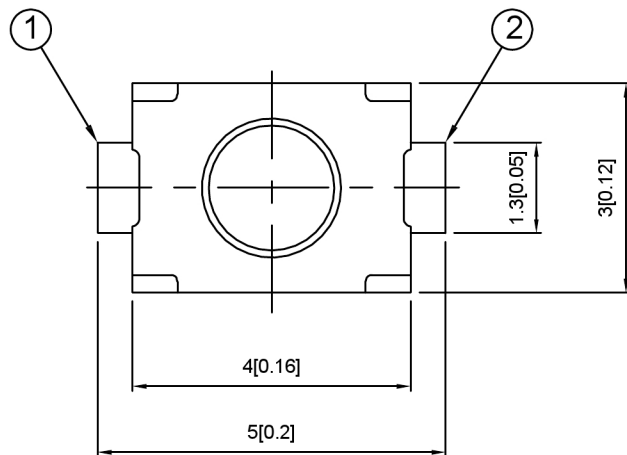


SPECIFICATION

Contact Rating:	50mA,12V DC
Contact Resistance:	100mΩ max
Insulation Resistance:	100mΩ min.500V DC
Dielectric Strength:	250V AC/1minute
Travel:	0.13mm
Operating Temp:	-30℃~+85℃
Storage Temp:	-30℃~+80℃

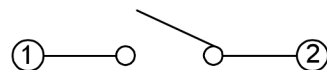
PCB MOUNTING PATTERN DIMENSION

The following soldering patterns are recommended for reflow soldering



PAPT NO	TS-1185-X-X-X-A
Operating Force	A:100gf B:160gf C:260gf
Height	H:A:2.0 B:2.5
Fixed column	A:With B:Without
Keystake	A:PA46 B:Silica gel

CIRCUIT DIAGRAM



⑤	Terminal	—	2	Brass (0.30t)	Plating silvering	—
④	Contact	—	1	F.ag/Sus	Natural	—
③	Base	—	1	LCP		—
②	Cover	—	1	Brass	Plating Nickel	—
①	Keystake	—	1	LCP		—
ITEM	PAPT NAMF	TER,NO	QTY	MATERIAL	FINISHING	REMARK

广东星坤科技股份有限公司

ΔX		日期
ΔX		
ΔX		
MARK		

文件工程章

DESCRIPTION	DATE	REVISED	APPROVED	UNSPECIFIED TOLERANCES
REVISIONS				
www.helloxkb.com www.helloxkb.cn www.xk-dg.cn				

DSND		SCALE: N/A	MODEL TYPE: TACT SWITCH
DWN		VIEW: ④	PART NO.: TS-1185-X-X-X-B
CHKD		UNIT: mm/in	DWG NO.:
APPD		SIZE: A4	
XKB INDUSTRIAL PRECISION CO.,LIMITED			WEIGHT
			SHEET 1/1
			REVISIC A0